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Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			$V_{DSS}$	-30	V
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) V <sub>GS</sub> = -10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	-2.5 -2.0	А
Maximum Continuous Body Diode Forward Current (Note 6)			Is	-1.5	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I <sub>DM</sub>	-10	A

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

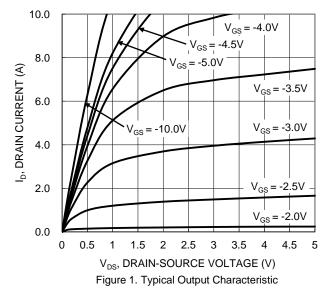
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		$P_{D}$	0.65	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ hetaJA}$	191	°C/W
Total Power Dissipation (Note 6)		P <sub>D</sub>	1.2	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ hetaJA}$	103	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30	1	_	V	$V_{GS} = 0V, I_D = -250\mu A$	
Zero Gate Voltage Drain Current $T_J = +25$ °C	I <sub>DSS</sub>	_	_	-1	μA	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-1.0	_	-2.1	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	
Static Drain-Source On-Resistance	7	_	76	95	m0	V <sub>GS</sub> = -10V, I <sub>D</sub> = -3.8A	
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	_	108	145	mΩ	$V_{GS} = -4.5V, I_D = -3.0A$	
Diode Forward Voltage	V <sub>SD</sub>		-0.85	-1.2	V	$V_{GS} = 0V$ , $I_S = -2.7A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C <sub>iss</sub>	1	254	_	pF	V <sub>DS</sub> = -25V, V <sub>GS</sub> = 0V f = 1.0MHz	
Output Capacitance	Coss	_	14	_	pF		
Reverse Transfer Capacitance	$C_{rss}$	_	7	_	pF		
Gate Resistance	$R_g$	_	54	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge	$Q_g$	1	3.1	_	nC		
Gate-Source Charge	$Q_{gs}$	_	0.8	_	nC	$V_{GS} = -4.5V, V_{DS} = -15V$ $I_{D} = -3.8A$	
Gate-Drain Charge	$Q_{gd}$	_	1.4	_	nC	- ID = -3.6A	
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.5	_	ns	$V_{DS} = -15V$ , $V_{GS} = -10V$ , $R_{G} = 6.0\Omega$ , $I_{D} = -1A$	
Turn-On Rise Time	t <sub>R</sub>	_	6.3	_	ns		
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	21.8	_	ns		
Turn-Off Fall Time	t <sub>F</sub>	1	13.1	_	ns		
Reverse Recovery Time	t <sub>RR</sub>	1	9.6	_	ns	I <sub>F</sub> = -1.0A, di/dt = 100A/μs	
Reverse Recovery Charge	$Q_{RR}$	_	2.4	_	nC	$I_F = -1.0A$ , $di/dt = 100A/\mu s$	

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.





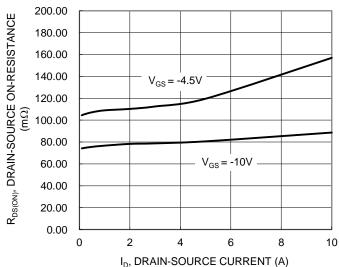
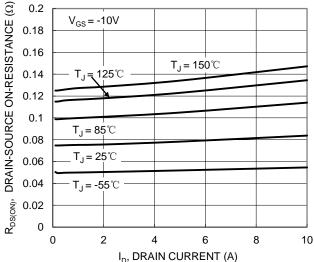
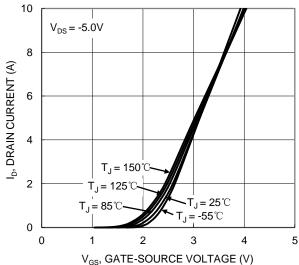


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage



I<sub>D</sub>, DRAIN CURRENT (A) Figure 5. Typical On-Resistance vs. Drain Current and Temperature



V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)
Figure 2. Typical Transfer Characteristic

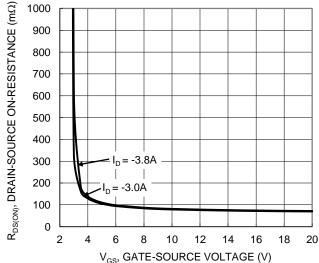
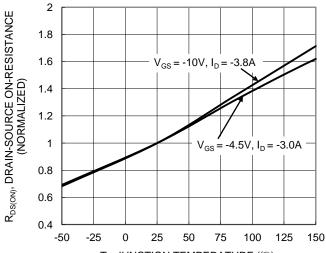


Figure 4. Typical Transfer Characteristic



 $\mathsf{T_J},\mathsf{JUNCTION}$  TEMPERATURE (°C) Figure 6. On-Resistance Variation with Temperature



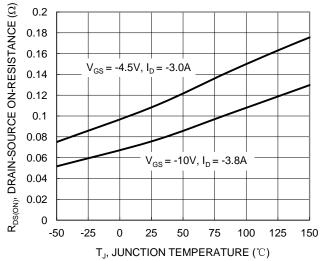


Figure 7. On-Resistance Variation with Temperature

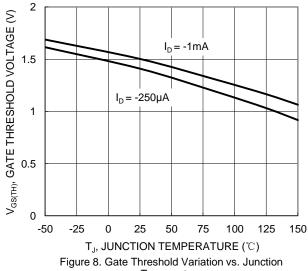
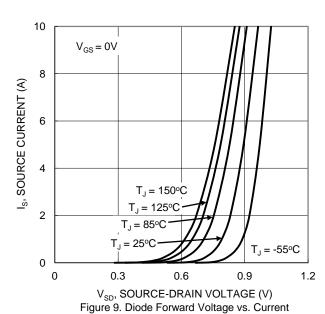
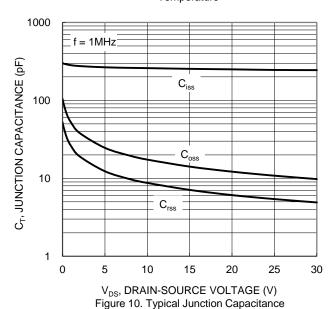


Figure 8. Gate Threshold Variation vs. Junction Temperature



8 6  $V_{GS}(V)$ 4  $V_{DS} = -15V, I_{D} = -3.8A$ 2

2 3 4 5 6  $Q_q$  (nC) Figure 11. Gate Charge



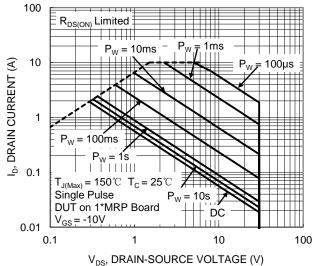


Figure 12. SOA, Safe Operation Area

0

0

1

10

7



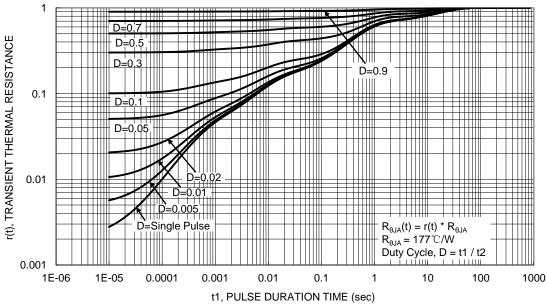


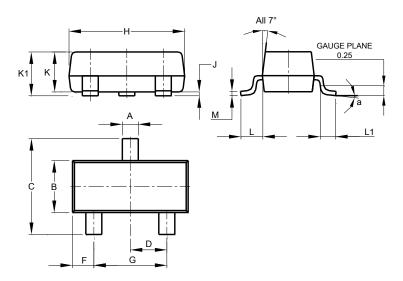
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23

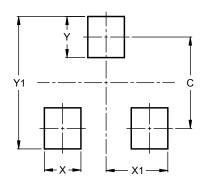


SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
C	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
М	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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